

10/552534

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Roberto Fenzi  
Title : PUNCTURE RESISTANT TEXTILE STRUCTURE,  
ESPECIALLY FOR SHOE SOLES  
International  
Application No. : PCT/IT2004/000208  
International  
Filing Date : April 14, 2004  
Docket No. : 38853  
Customer No. : 000116

Mail Stop PCT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

In accordance with 37 C.F.R. § 1.98, applicant is submitting herewith Form PTO-1449 listing references for consideration by the Examiner. Copies of the references are not included because they were previously sent by the International Bureau or are otherwise not required.

Respectfully submitted  
PEARNE & GORDON LLP

By: John P. Murtaugh  
John P. Murtaugh, Reg. No. 34226

1801 East 9<sup>th</sup> Street  
Suite 1200  
Cleveland, Ohio 44114-3108  
(216) 579-1700

Date: 10-11-05

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Form PTO-1449	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO. 38853	SERIAL NO.
INFORMATION DISCLOSURE CITATION BY APPLICANT (USE SEVERAL SHEETS IF NECESSARY)		APPLICANT: <b>10/552534</b> Roberto Fenzi	
		FILING DATE: herewith	GROUP ART UNIT:

**U.S. PATENT DOCUMENTS**

Examiner Initial		Document No.	Date	Name	Class	Subclass	Filing Date If Appropriate
	A	5,480,706	01/1996	Li, et al.			
	B	5,677,029	10/1997	Prevorsek, et al.			
	C	5,880,042	03/1999	Schuster, et al.			
	D	2003/180517	09/2003	Karall			
	E	6,368,989	04/2002	Pascual, et al.			
	F						
	G						
	H						
	I						
	J						
	K						

**FOREIGN PATENT DOCUMENTS**

		Document No.	Date	Country	Class	Subclass	Translation
	L	WO 01/68361	09/2001	PCT			
	M	WO 01/51263	07/2001	PCT			
	N						
	P						
	Q						

**OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)**

	R	
	S	
	T	

Examiner:

Date Considered

**\*Examiner:** Initial if reference considered, regardless of whether citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.